

# Reference Index (1/4)

No.	Article
1	Japanese Laid-open P60-246635
2	Japanese Laid-open P01-298180
3	Japanese Laid-open P02-94647
4	International Laid-open P64-500072 (USP4917556)
5	Japanese Laid-open P02-61064 (USP4969790)
6	Terminological Dictionary of Semiconductor Equipment
7	Japanese Laid-open P01-310553
8	Japanese Laid-open P01-251734
9	Japanese Laid-open P63-15 <sup>3</sup> 2270
10	Japanese Laid-open P62-044571
11	Japanese Laid-open P62-050463
12	Semicon News('84/3)
13	Japanese Laid-open P02-106037
14	Japanese Laid-open P57-29577
15	Japanese Laid-open P62-207866
16	VLSI Process Handbook
17	Japanese Published P62-33745
18	Latest trend of process automation
19	Semicon News(84/12)
20	Japanese Laid-open U63-057734
21	Japanese Laid-open P63-133521
22	Japanese Laid-open P62-216315
23	Japanese Laid-open P60-52574 (USP4675096)
24	Japanese Laid-open U04-82841
25	Japanese Laid-open P58-93321
26	Semiconductor World (P136,137)('90/9)
27	Electronic Materials ( '89/3)
28	Solid State('90/10)
29	Solid State('90/12)
30	Japanese Laid-open P03-19252

2000-01-01 14:50:00

## Reference Index (2/4)

No.	Article
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31	Japanese Laid-open P02-052449
32	Japanese Laid-open U58-95636
33	Japanese Laid-open P01-316957
34	Japanese Laid-open P02-179946
35	Japanese Laid-open P62-132321
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37	WOA 8707309 (A)
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39	EPA 0246453(A)
40	Japanese Laid-open P02-65252
41	Japanese Laid-open P01-135015
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43	Japanese Laid-open P61-250185
44	EPA 0367423 (USP4923584)
45	USP 4643629 (A)
46	Semiconductor World (P106~P111, '90/9)
47	Semiconductor World (P122~125, '90/9)
48	Japanese Laid-open P 02-2224242
49	Japanese Laid-open U02-26229
50	Japanese Laid-open P 58-108641
51	Semiconductor World (P110~113)('89/10)
52	Semiconductor World (P52~53)('91/8)
53	EP search report ('92/1)
54	EP search report ('98/4)
55	EP search report ('99/3)
56	Japanese Laid-open P 01-120811

## Reference Index (3/4)

No.	Article
57	JP application No. 3-234408, Office action
58	JP No. 2646905, Notification of revocation ('98/12)
59	JP No. 2646905, Notification of revocation ('99/7)
60	JP No. 2646905, Decision of opposition
61	JP application No. 2-225321, Office action
62	JP application No. 2-225321, Interview record
63	JP application No. 8-335329, Office action ('97/9)
64	JP application No. 8-335329, Office action ('98/3)
65	JP No. 2816139, Notification of revocation
66	JP No. 2816139, Decision of opposition
67	JP application No. 9-329873, Office action ('98/6)
68	JP application No. 9-329873, Office action ('98/10)
69	JP No. 2942527, Notification of revocation
70	JP No. 2942527, Decision of opposition
71	JP application No. 11-001263, Office action
72	JP application No. 2000-054448, Office action
73	JP application No. 2000-054449, Office action
74	JP application No. 2000-054450, Office action
75	JP application No. 2000-054451, Office action
76	JP application No. 2000-054452, Office action
77	EP91307625, Office action
78	EP91307625, Summons to attend oral proceedings
79	EP91307625, Communication of a notice of opposition
80	EP91307625, Interlocutory decision
81	EP91307625, Minutes of the oral proceedings
82	EP97111628, Office action (1999/12)
83	EP97111628, Office action (2000/11)
84	EP97111628, Office action (2001/6)

## Reference Index (4/4)

No.	Article
85	EP98106162, Office action (2000/11)
86	EP98106162, Office action (2001/6)
87	KR application No. 14984/91, Office action
88	KR patent No. 184682, Decision to opposition
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93	KR patent No. 212819, Decision to opposition